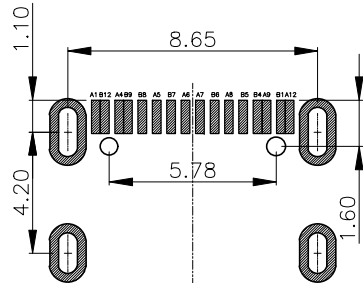
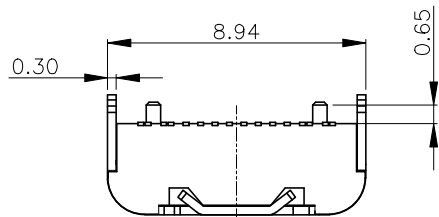
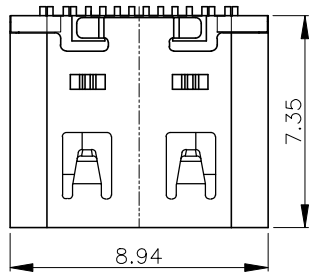
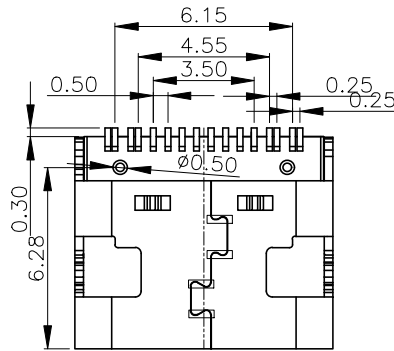
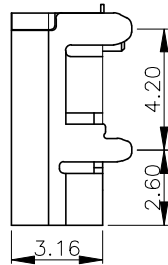
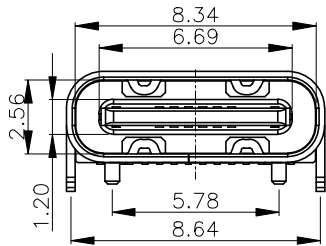




REV.	ECN NO OR DESCRIPTION	REVISED	DATE



PCB LAYOUT(Recommend)
(General Tolerance:±0.05)

NOTE:

- MATERIAL SPECIFICATION:
 - HOUSING:HIGH TEMPERATURE RESISTANT PLASTIC,UL94 V-0.
 - CONTACTS:COPPER ALLOY
 - MID PLATE: STAINLESS STEEL
 - FRONT SHELL: STAINLESS STEEL
- PLATING SPECIFICATION:
 - CONTACTS:
 - Ni 50u" MIN. UNDER PLATED OVER ALL.
 - Au PLATED ON THE FUNCTIONAL AREA OF CONTACT.
 - (GOLD PLATING THICKNESS FOLLOW THE P/N)
 - PLATING SPECIFICATIONS OF THE SOLDER AREA FOLLOW THE P/N
 - FRONT SHELL:
 - SEE TABLE1.
 - SHIELD PLATE&EMI PLATE:
 - CLEAR ONLY
- MECHANICAL PERFORMANCE,
 - INSERTION FORCE: 0.5~2.0kgf.
 - REMOVAL FORCE: 0.8kgf~2.0kgf.
 - DURABILITY: 10000 CYCLES.
- ELECTRICAL PERFORMANCE,
 - CURRENT RATING:3.0A
VOLTAGE RATING:5.0V
 - LLCR:
 - VBUS & GND PINS AND OTHER PINS: 40mA/PIN MAX.
 - SHIELD: 50mA/MAX.
 - LLCR MAX. CHANGE OF ALL PINS: 10mA.
 - INSULATION RESISTANCE: 100MΩ MIN
 - DIELECTRIC WITHSTAND VOLTAGE,AC 100V FOR 1 MINUTE.
- ENVIRONMENTAL PERFORMANCE:
 - OPERATING TEMPERATURE: -25°C~+85°C.
- IR REFLOW:
 - THE PEAK TEMPERATURE ON THE BOARD SHALL BE MAINTAINED FOR 10 SECONDS AT 260°C.

UNLESS OTHERWISE SPECIFIED TOLERANCES

DECIMALS:	ANGLES:
X. :±0.20	X° :±2°
X.X :±0.15	X.X° :±1°
X.XX :±0.10	



东莞市汉博电子科技有限公司
DONGGUAN HANBO TECHNOLOGY CO., LTD

TITLE	TYPE-C 16Pin板上型 带双压片 7.35mm			
DWN	xiong	MC-107DM		
CHKD	lee	SCALE:1:1	UNIT: mm	
APVD	wang	SIZE: A4	SHEET:10F 1	REV: A4

CUSTOMER COPY